

06-01-1998



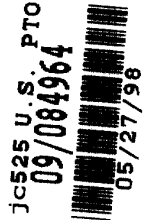
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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

PATENT

5/27/98

REQUEST FOR ASSIGNMENT RECORDAL



Box Assignments
Honorable Commissioner of Patents and Trademarks
Washington, D.C. 20231

Dear Sir:

Please record the attached assignment document.

1. Names of conveying parties: SUNG-SOON PARK, JI-WON LEE, YOON-HO JUN, HUN-SOO KIM and DONG-SIK ZANG
2. Name and address of receiving party: Samsung Display Devices Co., Ltd.
575 Shin-dong, Paldal-gu,
Suwon-city, Kyungki-do,
REPUBLIC OF KOREA
3. Nature of conveyance: Assignment
Execution Date: March 24, 1998
4. Application No.:
The execution date of the patent application is March 24, 1998.
5. Name and address of party to whom correspondence concerning the attached document should be mailed:

LEYDIG, VOIT & MAYER
Suite 300
700 Thirteenth Street, N.W.
Washington, D.C. 20005

06/01/1998 SCHAPMAN 00000071 09084964

03 FC:581

72914/YPLEE

40.00 DP

PATENT

REEL: 9194 FRAME: 0370

6. Total number of patent applications involved: 1

7. Total fee: \$40.00

☒ Enclosed

☒ The Commissioner is authorized to charge any deficiencies in the fee payment accompanying this communication and to credit any excess payment of fees to Deposit Account No. 12-1216.

8. Statement and signature

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Date

May 27, 1978

Jeffrey A. Wyand

Registration No. 29,458

Total number of pages comprising cover sheet, attachments and document: 4

72914/YPLEE

PATENT
REEL: 9194 FRAME: 0371

ASSIGNMENT

In consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt of which is hereby acknowledged, the undersigned,

Sung-soon Park of 7-1206 Imkwang Apt., 1162 Maetan-dong, Paldal-gu, Suwon-city, Kyungki-do, Republic of Korea, Ji-won Lee of 207-1204 Hyundai Apt., 1240 Kwonsun-dong, Kwonsun-gu, Suwon-city, Kyungki-do, Republic of Korea, Yoon-ho Jun of 198-29 Maetan 2-dong, Paldal-gu, Suwon-city, Kyungki-do, Hun-soo Kim of 97-303 Banpo Apt., 1230 Banpo-dong, Seocho-gu, Seoul, Republic of Korea and Dong-sik Zang of 6-106 Samsung Apt., 1835-1 Kwonsun-dong, Kwonsun-gu, Suwon-city, Kyungki-do, Republic of Korea

hereby sell, assign and transfer to

Samsung Display Devices Co., Ltd.

a corporation organized under the laws of Korea

575 Shin-dong, Paldal-gu, Suwon-city, Kyungki-do, Republic of Korea
(Hereinafter called the Assignee), its successors and assigns, the entire right, title, and interest in and to:

I) the application for United States Letters Patent entitled

CONDUCTIVE COMPOSITION, TRANSPARENT CONDUCTIVE LAYER FORMED THEREOF,
AND METHOD FOR FORMING THE SAME

which was executed by the undersigned on March 24, 1998
or filed on _____ and accorded Serial No. _____
(hereinafter called the Application);

- ii) any and all inventions and improvements which are described in the Application;
- iii) any and all United States Letters Patents which may be granted on the Application (hereinafter called the Patent);
- iv) any and all divisions, continuations, substitutes, or reissues of the Application or Patent; and
- v) All benefits under the International Convention for the protection of Industrial Property.

It is hereby authorized that the above-mentioned assignee insert in this instrument the filing date and serial number of said application.


It is hereby authorized and requested that the Commissioner of Patents issue any and all of said Letters Patent, when granted, to said Assignee.

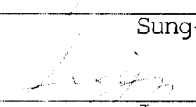
Further, it is agreed that, when requested, without charge to but at the expense of said Assignee, the undersigned will execute all divisional, continuing, substitute, or reissue patent applications, execute all additional assignments and other writings and provide all reasonable assistance requested by the Assignee.

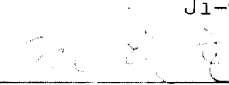
Signed at 575 Shin-dong, Paldal-gu, Suwon-city, Kyungki-do, Rep. of Korea
_____ this 24th day of March, 1998.

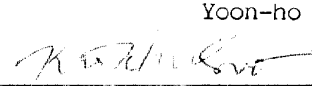
WITNESS(ES):


INVENTORS(S):



Sung-soon Park


Ji-won Lee


Yoon-ho Jun


Hun-soo Kim


Dong-sik Zang
